

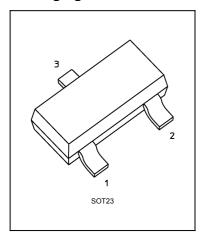
Schottky Barrier Diode Silicon Epitaxial

TBAT54,TBAT54A,TBAT54C,TBAT54S

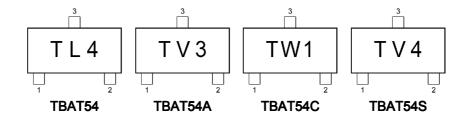
1. Applications

· Ultra-High-Speed Switching

2. Packaging



3. Marking

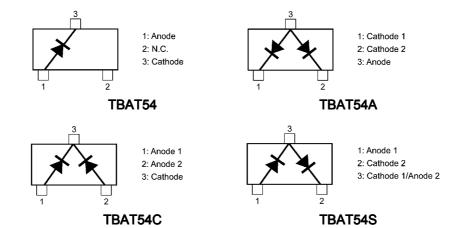


Part Number	Marking Code	Configuration
TBAT54	TL4	single
TBAT54A	TV3	common anode
TBAT54C	TW1	common cathode
TBAT54S	TV4	series

Start of commercial production



4. Internal Circuit



5. Absolute Maximum Ratings (Note) (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Note	Rating	Unit
Peak reverse voltage	V_{RM}		35	V
Reverse voltage	V _R		30	
Average rectified current	Io	(Note 3)	200	mA
Peak forward current	I _{FM}	(Note 3)	300	
Non-repetitive peak forward surge current	I _{FSM}	(Note 1), (Note 3)	1	Α
Power dissipation	P _D	(Note 2), (Note 3)	320	mW
Junction temperature	Tj		150	ç
Storage temperature	T _{stg}		-55 to 150	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Measured with a 10 ms pulse.

Note 2: Mounted on an FR4 board (25.4 mm \times 25.4 mm \times 1.6 mm, Cu Pad: 0.42 mm² \times 3)

Note 3: Unit rating. Total rating = unit rating \times 1.5 (TBAT54A,TBAT54C), Total rating = unit rating \times 0.7 (TBAT54S)



6. Electrical Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Forward voltage	V _F	I _F = 0.1 mA	_	0.16	_	V
		I _F = 1 mA		0.21	0.32	
		I _F = 10 mA	_	0.28	0.39	
		I _F = 30 mA	_	0.37	0.50	
		I _F = 100 mA		0.45	0.58	
Reverse current	I _R	V _R = 25 V	_	0.6	2	μА
Reverse recovery time	t _{rr}	I _F = 10 mA		1.5	I	ns

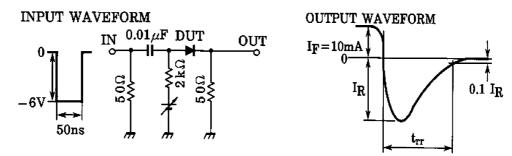


Fig. 6.1 Reverse recovery time (t_{rr}) test circuit

7. Usage Considerations

Schottky barrier diodes (SBDs) have reverse leakage greater than other types of diodes. This makes SBDs
more susceptible to thermal runaway under high-temperature and high-voltage conditions. Thus, both
forward and reverse power losses of SBDs should be considered for thermal and safety design.

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3
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8. Characteristics Curves (Note)

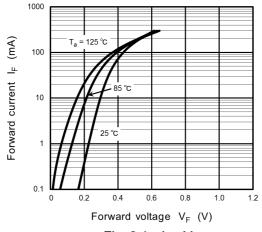


Fig. 8.1 I_F - V_F

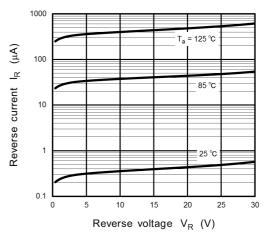


Fig. 8.2 I_R - V_R

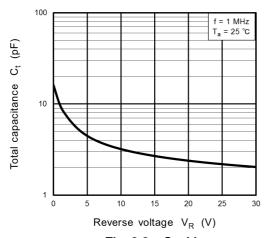


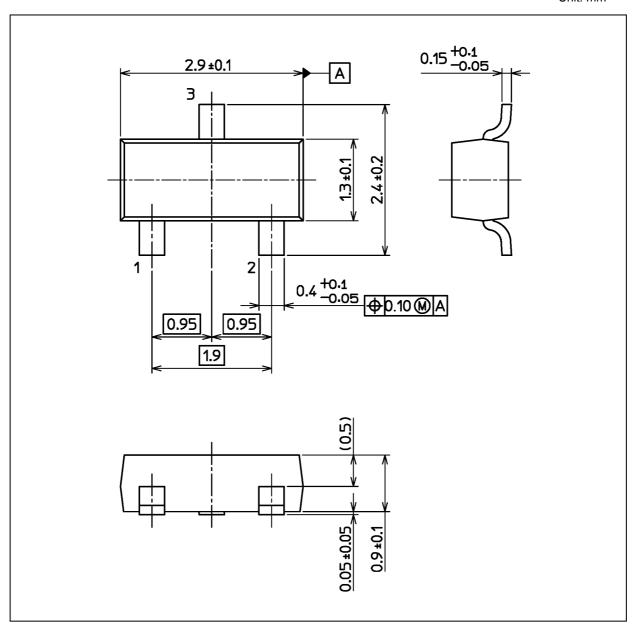
Fig. 8.3 Ct - VR

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



Package Dimensions

Unit: mm



Weight: 0.009 g (typ.)

	Package Name(s)	
Nickname: SOT23		



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